

600V, 10A, Trench FS II Fast IGBT

General Description:

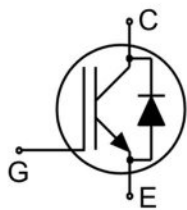
Using MJ's proprietary trench design and advanced FS (Field Stop) second generation technology, the 600V Trench FSII IGBT offers superior conduction and switching performances, and easy parallel operation;

Features

- ◆ Trench FSII Technology offering
- ◆ Very low $V_{CE(sat)}$
- ◆ High speed switching
- ◆ Positive temperature coefficient in $V_{CE(sat)}$
- ◆ Very tight parameter distribution
- ◆ High ruggedness, temperature stable behavior

Application

- ◆ Air Condition
- ◆ Inverters
- ◆ Motor drives



Schematic diagram



TO-220

Package Marking and Ordering Information

Device	Device Package	Device Marking
MJ10TD60B	TO-220	MJ10TD60B

Absolute Maximum Ratings ($T_c=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Units
Collector-Emitter Voltage	V_{CES}	600	V
Gate- Emitter Voltage	V_{GES}	± 30	V
Collector Current	I_C	20	A
Collector Current @ $T_c = 100^{\circ}\text{C}$	I_C	10	A
Pulsed Collector Current, t_p limited by T_{jmax}	I_{Cplus}	30	A
turn off safe operating area, $V_{CE}=600\text{V}$, $T_j=150^{\circ}\text{C}$	-	30	A
Diode Continuous Forward Current @ $T_c = 100^{\circ}\text{C}$	I_F	10	A
Diode Maximum Forward Current	I_{FM}	30	A
Power Dissipation @ $T_c = 25^{\circ}\text{C}$	P_D	83	W
Power Dissipation @ $T_c = 100^{\circ}\text{C}$	P_D	41.5	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to +175	$^{\circ}\text{C}$
Maximum Temperature for Soldering	T_L	260	$^{\circ}\text{C}$
Short circuit withstand time $V_{GE}=15.0\text{V}$, $V_{CC}\leq 400\text{V}$, Allowed number of short circuits<1000Time between short circuits: $\geq 1.0\text{s}$, $T_j\leq 150^{\circ}\text{C}$	t_{sc}	5	us

Thermal Characteristic

Parameter	Symbol	Value	Units
Thermal Resistance, Junction to case for IGBT	$R_{\theta JC}$	1.80	$^{\circ}\text{C/W}$
Thermal Resistance, Junction to case for Diode	$R_{\theta JC}$	2.35	$^{\circ}\text{C/W}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	65	$^{\circ}\text{C/W}$

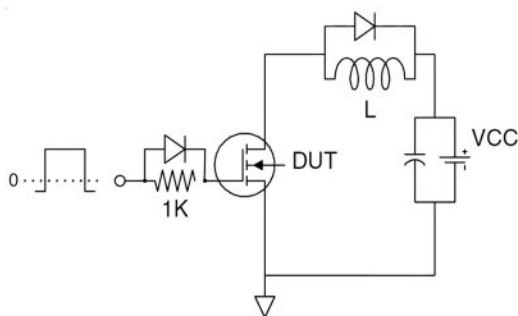
Electrical Characteristics (T_c=25°C unless otherwise noted)

Parameter	Symbol	Test Conditions		Value			Units
				Min	Typ	Max	
Static Characteristics							
Collector-Emitter Breakdown Voltage	V _{(BR)CES}	V _{GE} =0V,I _{CE} =1mA		600	-	-	V
Collector-Emitter Leakage Current	I _{CES}	V _{GE} =0V,V _{CE} =600V		-	-	4	uA
Gate to Emitter Forward Leakage	I _{GES(F)}	V _{GE} =+30V,V _{CE} =0V		-	-	100	nA
Gate to Source Reverse Leakage	I _{GES(R)}	V _{GE} =-30V,V _{CE} =0V		-	-	100	nA
Collector-Emitter Saturation Voltage	V _{CE(sat)}	I _C =10A V _{GE} =15V	T _J =25°C	-	1.7	1.9	V
			T _J =100°C	-	1.9	-	V
Gate Threshold Voltage	V _{GE(th)}	I _C =1mA, V _{CE} =V _{GE}		4.0	5.0	6.0	V
Dynamic Characteristics							
Input Capacitance	C _{ies}	V _{CE} =25V,V _{GE} =0V, f=1MHz		-	1127	-	pF
Output Capacitance	C _{Oss}			-	40	-	pF
Reverse Transfer Capacitance	C _{rss}			-	24	-	pF
Total Gate Charge	Q _g	V _{CC} =480V, I _C =10A V _{GE} =15V		-	44	-	nC
Gate to Emitter Charge	Q _{ge}			-	10	-	nC
Gate to Collector Charge	Q _{gc}			-	19	-	nC
Short circuit collector current Max.1000 short circuits Time between short circuits: ≥1.0s	I _{C(SC)}	V _{GE} =15V,V _{CC} ≤400V, t _{sc} ≤5us,T _J ≤150°C		-	50	-	A
Switching Characteristics							
Turn-on Delay Time	t _{d(ON)}	V _{CC} =400V,I _C =10A V _{GE} =0/15V, R _g =5Ω Inductive Load		-	20	-	ns
Rise Time	t _r			-	15	-	ns
Turn-Off Delay Time	t _{d(OFF)}			-	73	-	ns
Fall Time	t _f			-	18	-	ns
Turn-On Switching Loss	E _{on}			-	0.21	-	mJ
Turn-Off Switching Loss	E _{off}			-	0.11	-	mJ
Total Switching Loss	E _{ts}			-	0.32	-	mJ

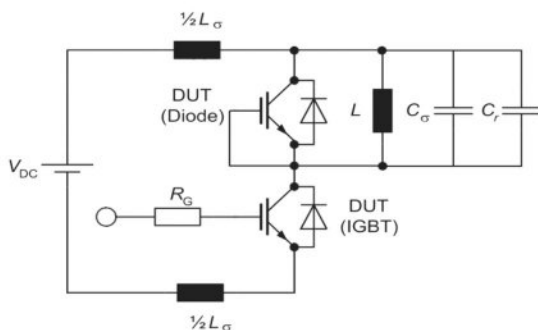
Electrical Characteristics of the Diode (T_c= 25°C unless otherwise specified):

Parameter	Symbol	Test Conditions	Rating			Units
			Min	Typ	Max	
Diode Forward Voltage	V _{FM}	I _F =10A	-	1.5	1.7	V
Reverse Recovery Time	T _{rr}	I _F =10A,di/dt=200A/uS	-	158	-	ns
Diode Peak Reverse Recovery Current	I _{RRM}		-	5.8	-	A
Reverse Recovery Charge	Q _{rr}		-	0.5	-	uC
Pulse width ttp≤380μs,δ≤2%						

Test Circuit

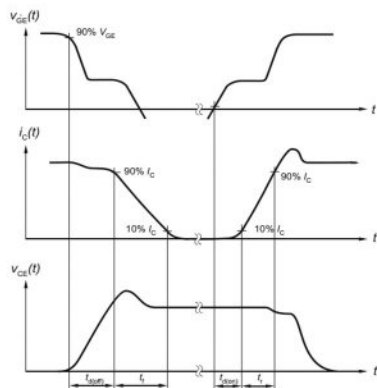


Gate Charge Test Circuit

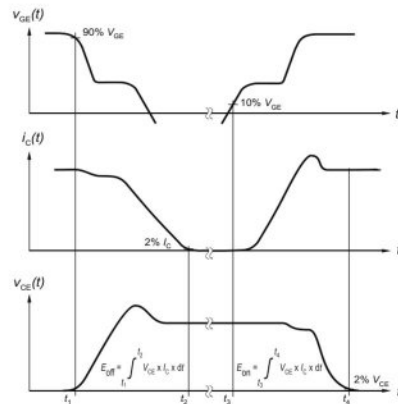


Switch Time Test Circuit

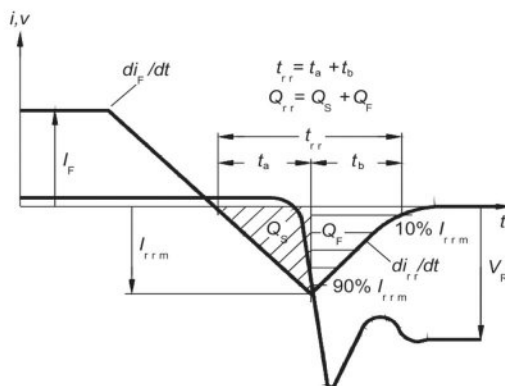
Switching characteristics



definition of switching times

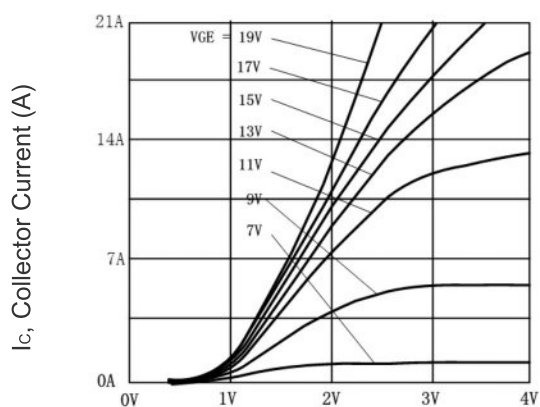


definition of switching losses

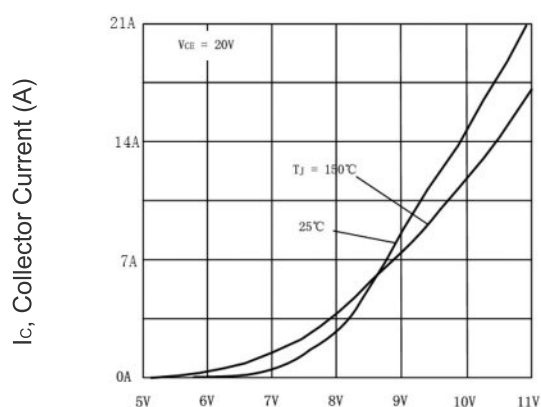


Definition of diode switching characteristics

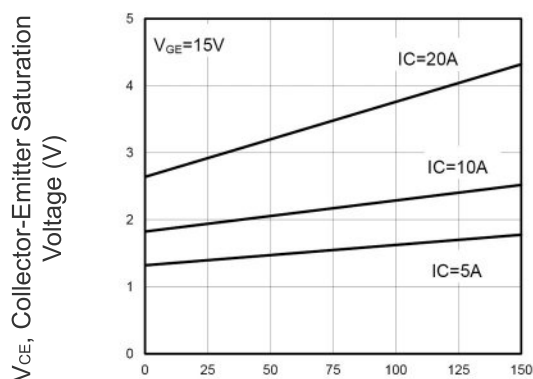
Typical Electrical and Thermal Characteristics



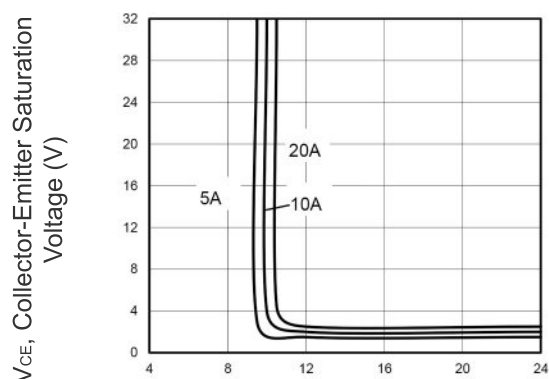
V_{CE} , Collector-Emitter Voltage (V)
Figure 1 Output Characteristics



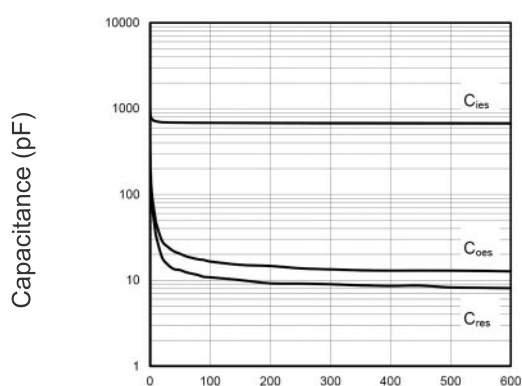
V_{GE} , Gate-Emitter Voltage (V)
Figure 2 Transfer Characteristics



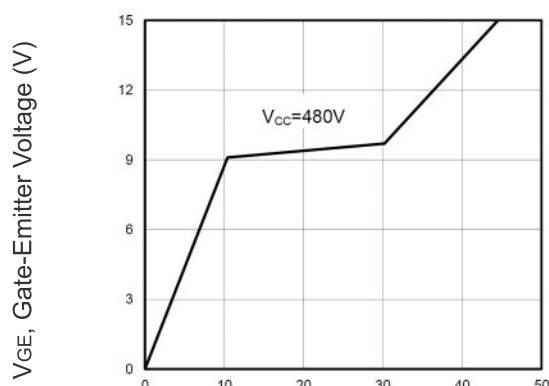
T_J , Junction Temperature ($^{\circ}\text{C}$)
Figure 3 V_{CEsat} vs. Case Temperature



V_{GE} , Gate-Emitter Voltage (V)
Figure 4 Saturation Voltage vs. V_{GE}

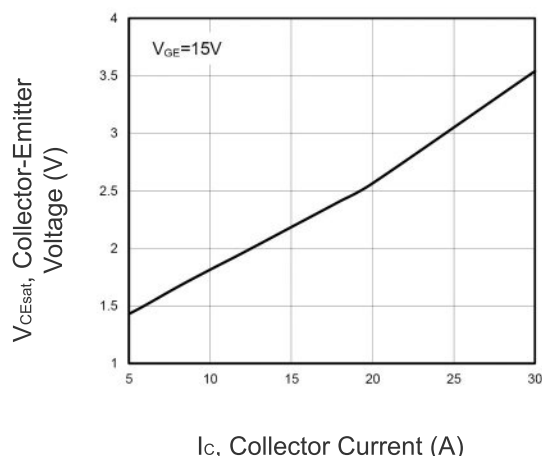
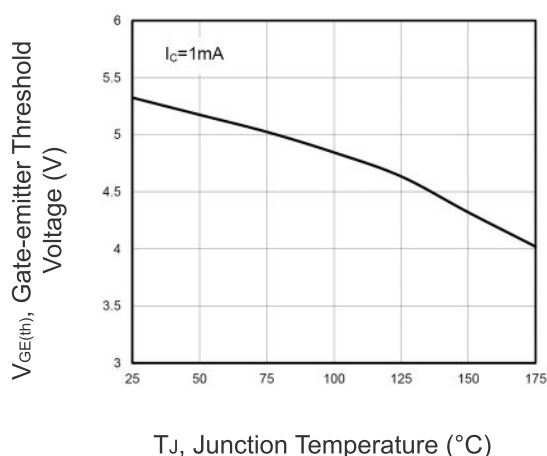
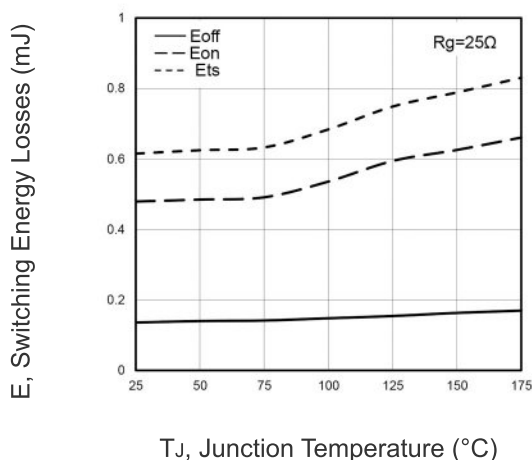
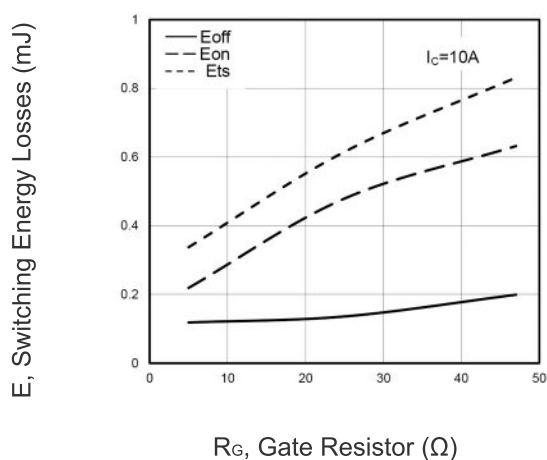
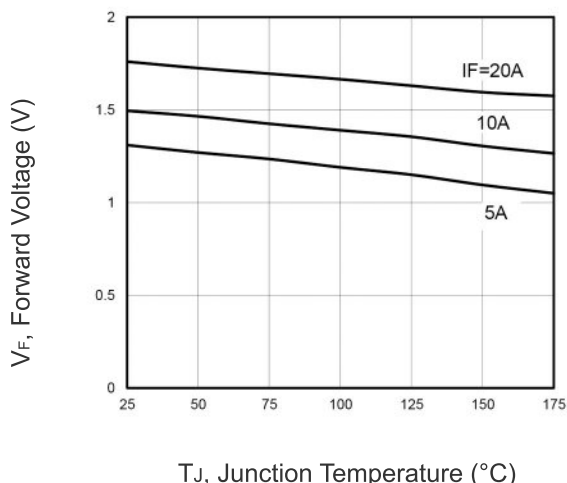
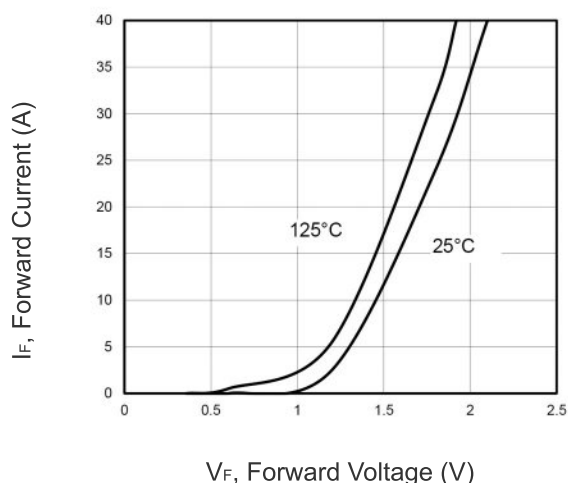


V_{CE} , Collector-Emitter Voltage (V)
Figure 5 Capacitance Characteristics



Q_G , Total Gate Charge (nC)
Figure 6 Gate charge waveform

Typical Electrical and Thermal Characteristics



Typical Electrical and Thermal Characteristics

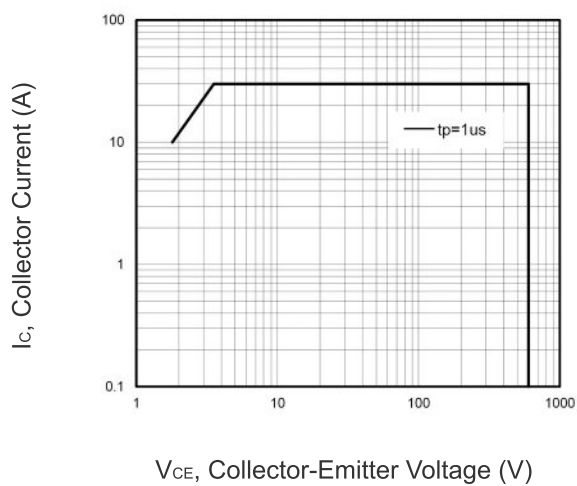
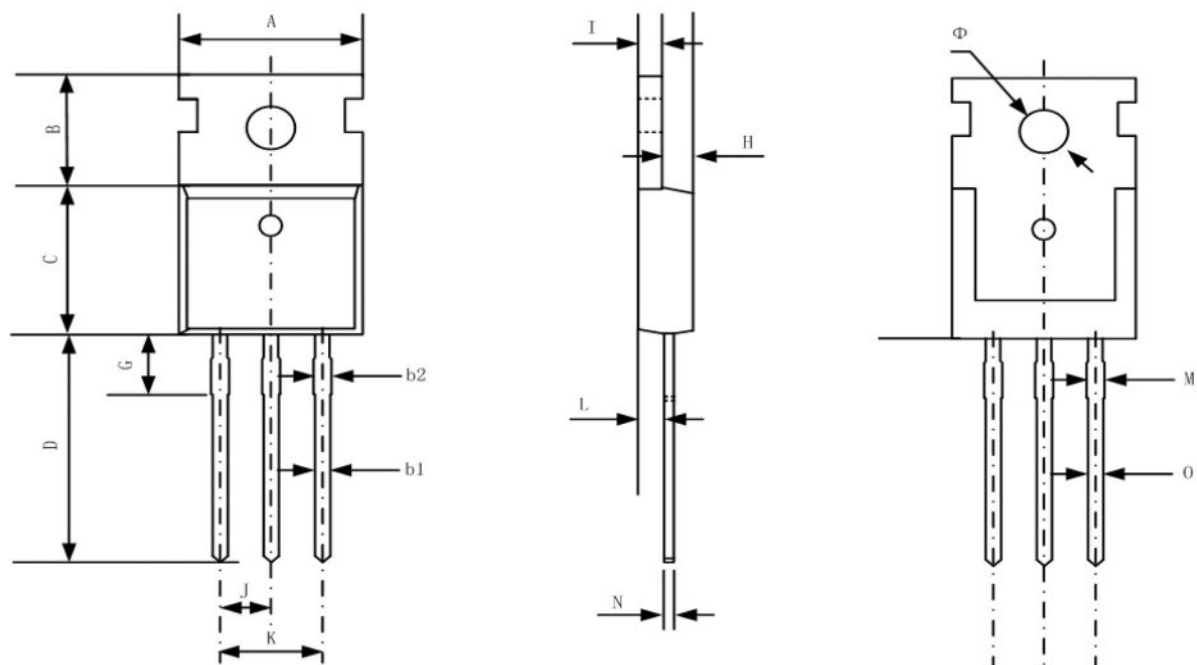


Figure 13 Forward Bias Safe Operating Area

TO-220-3L-C Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	9.70	10.20	0.38	0.40
B	6.30	6.70	0.25	0.26
C	9.00	9.47	0.35	0.37
D	12.78	13.38	0.50	0.53
G	2.65 REF		0.104 REF	
H	3.00	3.40	0.12	0.13
I	1.25	1.40	0.05	0.06
J	2.40	2.70	0.09	0.11
K	5.00	5.15	0.20	0.20
L	2.20	2.60	0.09	0.10
M	1.25	1.45	0.05	0.06
N	0.45	0.60	0.02	0.02
O	0.70	0.90	0.03	0.04
Φ	3.6 REF		0.142 REF	

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